



**THE DATASHEET OF
ICS507M-01ILF**



Description

The ICS507-01 is an inexpensive, simple way to generate a low jitter 155.52 MHz (or other high speed) differential PECL clock output from a low frequency crystal input. Using Phase-Locked-Loop (PLL) techniques, the devices use a standard fundamental mode crystal to produce output clocks up to 200 MHz.

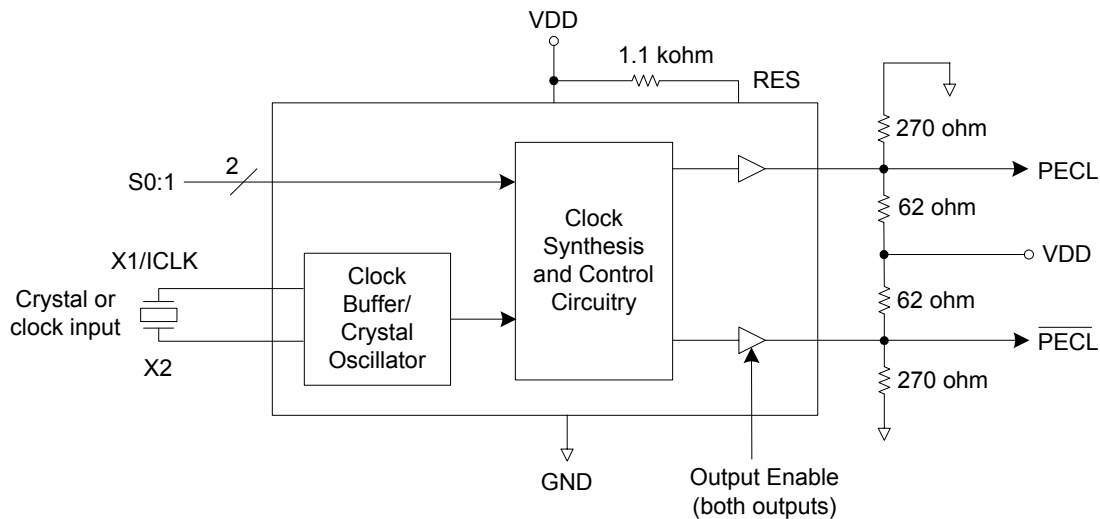
Stored in each chip's ROM is the ability to generate a selection of different multiples of the input reference frequency, including an exact 155.52 MHz clock from common crystals. For lowest jitter and phase noise on a 155.52 MHz clock, a 19.44 MHz crystal and the x8 selection can be used.

This product is intended for clock generation. It has low output jitter (variation in the output period), but input to output skew and jitter are not defined nor guaranteed.

Features

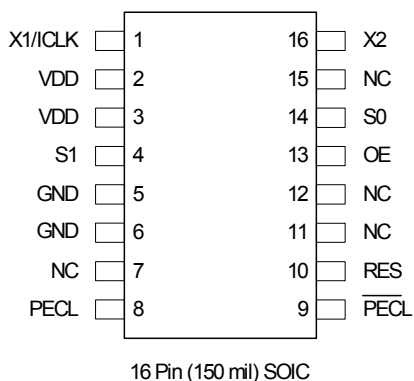
- Packaged in 16 pin SOIC
- Available in Pb (lead) free package
- Input crystal frequency of 5 - 27 MHz
- Input clock frequency of 5 - 52 MHz
- Enable usage of common low-cost crystal
- Differential PECL output clock frequencies up to 200 MHz
- Duty cycle of 49/51
- Operation voltage of 3.3 V or 5.0 V ($\pm 5\%$)
- Ideal for SONET applications and oscillator manufacturers
- Available in die form
- Industrial temperature versions available
- ICS507-02 is no longer available

Block Diagram



Output resistors shown are for unterminated lines. Refer to MAN09 for additional information.

Pin Assignment



* At 3.3V, use this selection to get 155.52 MHz from a 16 MHz input.

For lowest phase noise generation of 155.52 MHz, use a 19.44 MHz crystal and the 8X selection.

Clock Multiplier Select Table

| S1 | S0 | Multiplier |
|----|----|------------|
| 0 | 0 | 9.72X* |
| 0 | M | 10X |
| 0 | 1 | 12X |
| M | 0 | 6.25X |
| M | M | 8X |
| M | 1 | 5X |
| 1 | 0 | 2X |
| 1 | M | 3X |
| 1 | 1 | 4X |

0 = connect pin directly to ground

1 = connect pin directly to VDD

M = leave unconnected (floating)

Pin Descriptions

| Number | Name | Type | Description |
|--------|--------------------------|--------|---|
| 1 | XI/CLK | Input | Crystal Connection. Connect to a fundamental parallel mode crystal, or clock. |
| 2 | VDD | Power | Connect to +3.3 V or 5 V, and to VDD on pin 3. |
| 3 | VDD | Power | Connect to VDD on pin 2. Decouple with pin 5. |
| 4 | S1 | Input | Multiplier select pin 1. Determines output frequency per table above. |
| 5 | GND | Power | Connect to ground. |
| 6 | GND | Power | Connect to ground. |
| 7 | NC | — | No connect. Do not connect this pin to anything. |
| 8 | PECL | Output | PECL output. Connect to resistor load as shown on page 1. |
| 9 | $\overline{\text{PECL}}$ | Output | Complimentary PECL output. Connect to resistor load as shown on page 1. |
| 10 | RES | Input | Bias resistor input. Connect a resistor between this pin and VDD. |
| 11 | NC | — | No connect. Do not connect this pin to anything. |
| 12 | NC | — | No connect. Do not connect this pin to anything. |
| 13 | OE | Input | Output Enable. Tri-states both outputs when low. Internal pull-up. |
| 14 | S0 | Input | Multiplier select pin 0. Determines output frequency per table above. |
| 15 | NC | — | No connect. Do not connect this pin to anything. |
| 16 | X2 | Output | Crystal Connection. Connect to crystal, or leave unconnected for clock input. |

External Component Selection

The ICS507-01 requires a minimum number of external components for proper operation.

Decoupling Capacitors

Decoupling capacitors of 0.01 μ F should be connected between VDD and GND on pins 2 and 5, as close to the ICS507-01 as possible. Other VDD and GND connections should be connected to those pins, or to the VDD and GND planes on the board. A resistor must be connected between the RES (pin 10) and VDD.

Another four resistors are needed for the PECL outputs as shown on the block diagram on page 1. Suggested values of these resistors are shown in the Block Diagram, but they can be varied to change the differential pair output swing, and the DC level; refer to MAN09.

High Frequency Differential PECL Oscillators

The ICS507-01 plus a low frequency, fundamental mode crystal can build a high frequency differential output oscillator. For example, a 10 MHz crystal connected to the ICS507-01 with the 12X output selected (S1=0, S0=1) produces a 120 MHz PECL output clock.

Hi Frequency TCXO

Extending the previous application, an inexpensive, low frequency TCXO can be built and the output frequency can be multiplied using the ICS507-01. Since the output of the chip is phase-locked to the input, the ICS507-01 has no temperature dependence, and the temperature coefficient of the combined system is the same as that of the low frequency TCXO.

Hi Frequency VCXO

The bandwidth of the PLL is guaranteed to be greater than 10 kHz. This means that the PLL will track any modulation on the input with a frequency of less than 10 kHz. By using this property, a low frequency VCXO can be built, and the output can then be multiplied with the ICS507-01 to give a high frequency output, thereby producing a high frequency VCXO.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the ICS507-01. These ratings, which are standard values for ICS commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

| Item | Rating |
|--|---------------------|
| Supply Voltage, VDD | 7 V |
| All Inputs and Outputs | -0.5 V to VDD+0.5 V |
| Ambient Operating Temperature (commercial) | 0 to +70° C |
| Ambient Operating Temperature (industrial) | -40 to +85° C |
| Storage Temperature | -65 to +150° C |
| Soldering Temperature | 260° C |

Recommended Operation Conditions

| Parameter | Min. | Typ. | Max. | Units |
|---|-------|------|-------|-------|
| Ambient Operating Temperature (commercial) | 0 | – | +70 | °C |
| Ambient Operating Temperature (industrial) | -40 | – | +85 | °C |
| Power Supply Voltage (measured in respect to GND) | +3.15 | | +3.45 | V |

DC Electrical Characteristics

VDD=5 V, unless stated otherwise

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Units |
|---|-----------------|-----------------------------|---------|-------|---------|-------|
| Operating Voltage | VDD | | 3.0 | | 5.5 | V |
| Input High Voltage | V _{IH} | ICLK only | VDD/2+1 | VDD/2 | | V |
| Input Low Voltage | V _{IL} | ICLK only | | VDD/2 | VDD/2-1 | V |
| Input High Voltage | V _{IH} | S0, S1 | VDD-0.5 | | | V |
| Input Low Voltage | V _{IL} | S0, S1 | | | 0.5 | V |
| Output High Voltage | V _{OH} | Note 2 | VDD-1.2 | | | V |
| Output Low Voltage | V _{OL} | Note 2 | | | VDD-2.0 | V |
| Operating Supply Current | IDD | No load, 155.52 MHz, Note 3 | | 63 | | mA |
| Internal Crystal Capacitance, X1 and X2 | | Pins 1, 8 | | 26 | | pF |
| Input Capacitance | | S0, S1 | | 5 | | pF |

Notes:

1. All typical values are at 5.0 V and 25°C unless otherwise noted.
2. V_{OH} and V_{OL} can be set by the external resistor values on the PECL outputs.
3. I_{DD} includes the current through the external resistors, which can be modified.
4. The phase relationship between input and output can change at power up. For a fixed phase relationship, see one of the ICS zero delay buffers.
5. Except S1=0, S0=0 setting (This setting specific to 16 MHz in, 155.52 MHz out).

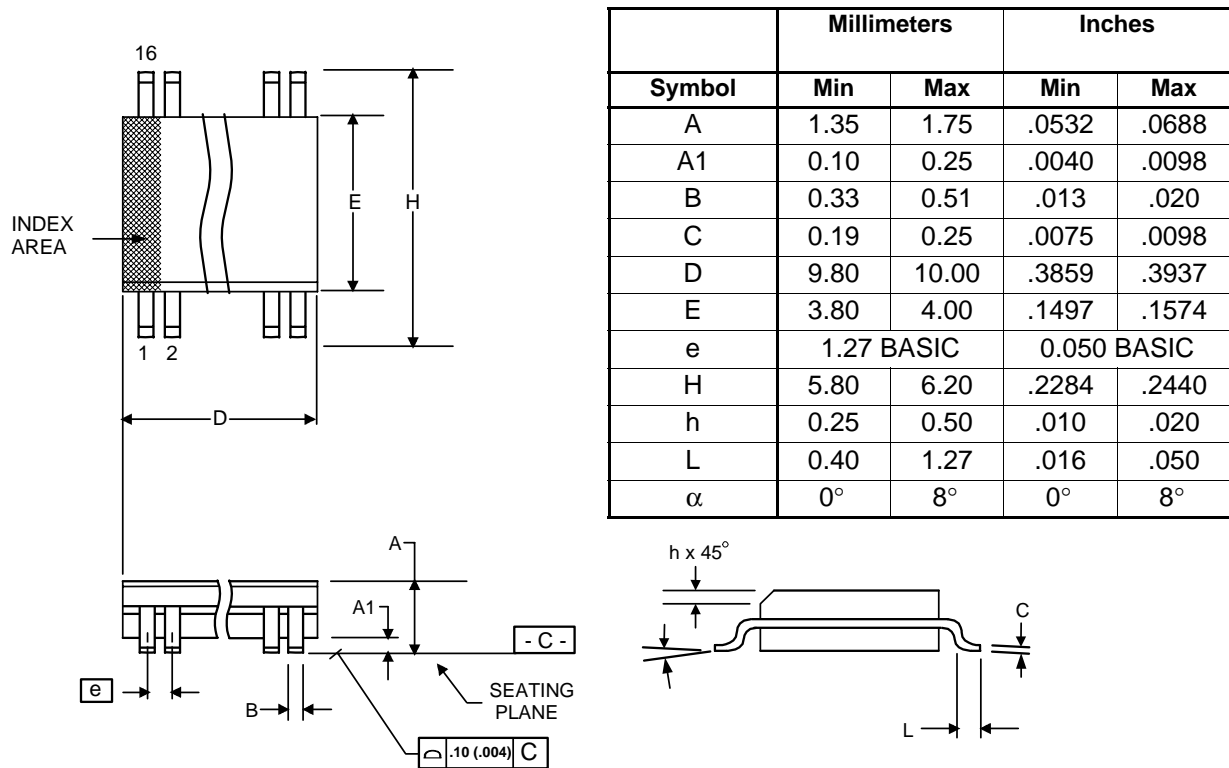
AC Electrical Characteristics

VDD = 3.3 V, 5 V unless stated otherwise

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Units |
|----------------------------------|-----------|---------------------|------|------|------|-------|
| Input Crystal Frequency | | | 5 | | 27 | MHz |
| Input Clock Frequency | | | 5 | | 52 | MHz |
| Output Frequency, ICS507-01 | f_{out} | VDD = 5 V | 10 | | 200 | MHz |
| | | VDD = 3.3 V | 10 | | 156 | MHz |
| Output Frequency, ICS507-01I | f_{out} | VDD = 3.3 V or 5 V | 10 | | 125 | MHz |
| Output Clock Duty Cycle | t_D | | 48 | | 52 | % |
| PLL Bandwidth | | | 10 | | | kHz |
| Absolute Clock Period Jitter | | Deviation from Mean | | ±75 | | ps |
| One Sigma Clock Period Jitter | | | | 20 | | ps |

Package Outline and Package Dimensions (16-pin SOIC, 150 Mil. Narrow Body)

Package dimensions are kept current with JEDEC Publication No. 95



Ordering Information

| Part/Order Number | Marking | Packaging | Package | Temperature | Min. Qty. |
|-------------------|--------------|------------------------------------|-------------|---------------|-------------|
| 507M-01 | ICS507M-01 | Tubes | 16-pin SOIC | 0 to +70° C | — |
| 507M-01T | ICS507M-01 | Tape and Reel | 16-pin SOIC | 0 to +70° C | 2500 pieces |
| 507M-01I | ICS507M-01I | Tubes | 16-pin SOIC | -40 to +85° C | — |
| 507M-01IT | ICS507M-01I | Tape and Reel | 16-pin SOIC | -40 to +85° C | 2500 pieces |
| 507M-01LF | ICS507M-01LF | Tubes | 16-pin SOIC | 0 to +70° C | — |
| 507M-01LFT | ICS507M-01LF | Tape and Reel | 16-pin SOIC | 0 to +70° C | 2500 pieces |
| 507M-01ILF | ICS507M01ILF | Tubes | 16-pin SOIC | -40 to +85° C | — |
| 507M-01ILFT | ICS507M01ILF | Tape and Reel | 16-pin SOIC | -40 to +85° C | 2500 pieces |
| 507M-01DSW | — | Probed wafers, cut, on sticky tape | | 0 to +70° C | 1 wafer |
| 507M-01DPK | — | Tested die in waffle pack | | 0 to +70° C | 1000 pieces |
| 507M-01DWF | — | Die on uncut, probed wafers | | 0 to +70° C | 1 wafer |

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